Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 6x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c771-i-p

TABLE 1-1: PIC16C717/770/771 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB6/T1OSO/T1CKI/P1C	RB6	TTL	CMOS	Bi-directional I/O(1)
	T1OSO		XTAL	Crystal/Resonator
	T1CKI	CMOS		TMR1 clock input
	P1C		CMOS	PWM P1C output
RB7/T1OSI/P1D	RB7	TTL	CMOS	Bi-directional I/O(1)
	T1OSI	XTAL		TMR1 crystal/resonator
	P1D		CMOS	PWM P1D output
VSS	VSS	Power		Ground reference for logic and I/O pins
VDD	VDD	Power		Positive supply for logic and I/O pins
AVSS(2)	AVSS	Power		Ground reference for analog
AVDD(2)	AVDD	Power		Positive supply for analog

Note 1: Bit programmable pull-ups.

2: Only in PIC16C770/771 devices.

FIGURE 2-3: REGISTER FILE MAP

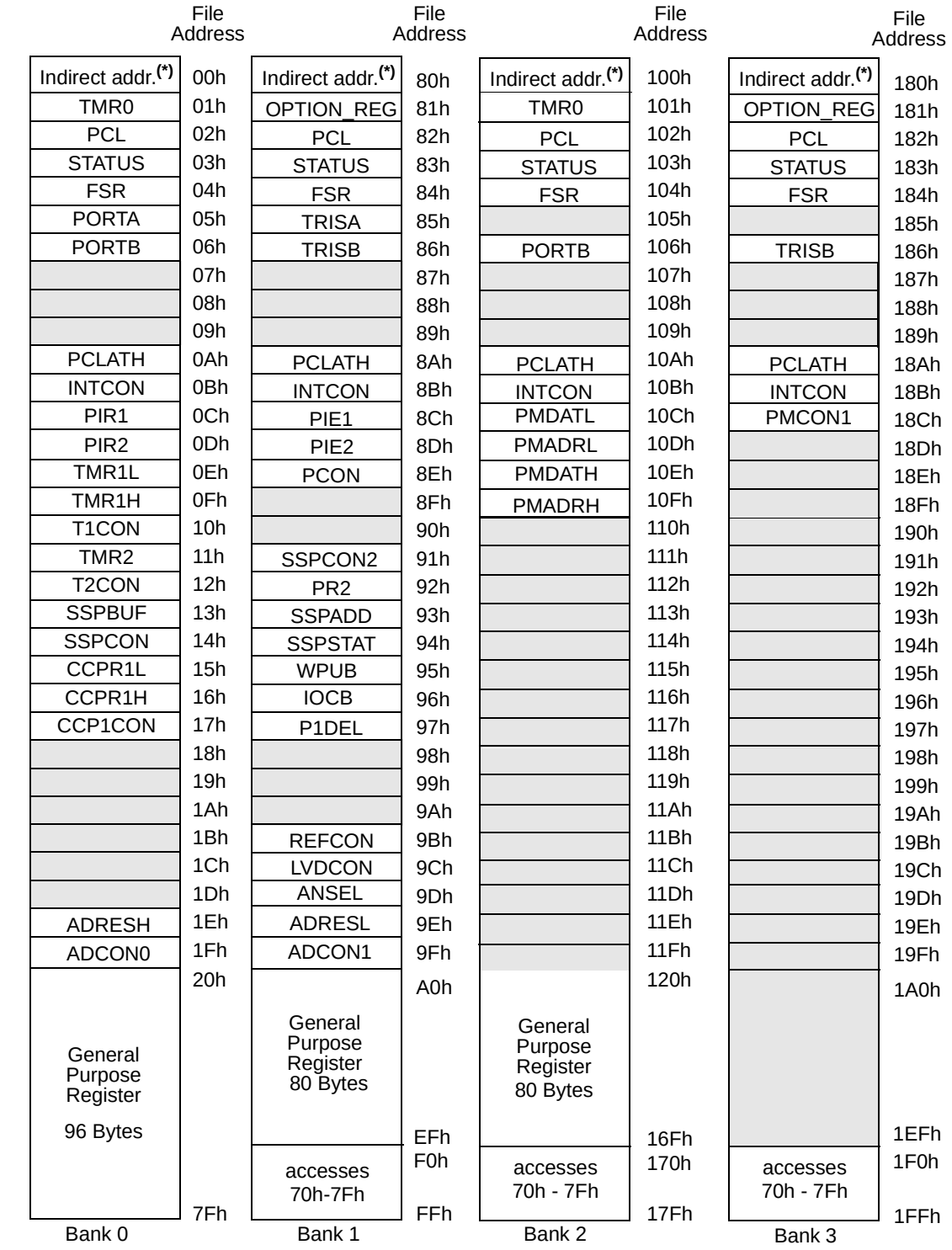


TABLE 2-1: PIC16C717/770/771 SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on Page:
Bank 1											
80h(3)	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	23
81h	OPTION_REG	$\overline{RBPU}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	15
82h(3)	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	22
83h(3)	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	14
84h(3)	FSR	Indirect data memory address pointer								xxxx xxxx	23
85h	TRISA	PORTA Data Direction Register								1111 1111	25
86h	TRISB	PORTB Data Direction Register								1111 1111	33
87h	—	Unimplemented								—	—
88h	—	Unimplemented								—	—
89h	—	Unimplemented								—	—
8Ah(1,3)	PCLATH	—	—	—	Write Buffer for the upper 5 bits of the Program Counter					---0 0000	22
8Bh(3)	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	16
8Ch	PIE1	—	ADIE	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE	-0-- 0000	17
8Dh	PIE2	LVDIE	—	—	—	BCLIE	—	—	—	0--- 0---	19
8Eh	PCON	—	—	—	—	OSCF	—	$\overline{POR}$	$\overline{BOR}$	---- 1-qq	21
8Fh	—	Unimplemented								—	—
90h	—	Unimplemented								—	—
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	69
92h	PR2	Timer2 Period Register								1111 1111	52
93h	SSPADD	Synchronous Serial Port (I^2C mode) Address Register								0000 0000	76
94h	SSPSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000	66
95h	WPUB	PORTB Weak Pull-up Control								1111 1111	34
96h	IOCB	PORTB Interrupt on Change Control								1111 0000	34
97h	P1DEL	PWM 1 Delay value								0000 0000	62
98h	—	Unimplemented								—	—
99h	—	Unimplemented								—	—
9Ah	—	Unimplemented								—	—
9Bh	REFCON	VRHEN	VRLEN	VRHOEN	VRLOEN	—	—	—	—	0000 ----	102
9Ch	LVDCON	—	—	BGST	LVDEN	LVV3	LVV2	LVV1	LVV0	--00 0101	101
9Dh	ANSEL	—	—	Analog Channel Select						--11 1111	25
9Eh	ADRESL	A/D Low Byte Result Register								xxxx xxxx	107
9Fh	ADCON1	ADFM	VCFG2	VCFG1	VCFG0	—	—	—	—	0000 ----	107

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented read as '0'.
Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: Other (non Power-up) Resets include external RESET through $\overline{MCLR}$ and Watchdog Timer Reset.

3: These registers can be addressed from any bank.

2.2.2.5 PIR1 REGISTER

This register contains the individual flag bits for the peripheral interrupts.

Note:	Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-5: PERIPHERAL INTERRUPT REGISTER 1 (PIR1: 0Ch)

U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIF	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

bit 7 **Unimplemented:** Read as ‘0’.

bit 6 **ADIF:** A/D Converter Interrupt Flag bit

1 = An A/D conversion completed
0 = The A/D conversion is not complete

bit 5-4 **Unimplemented:** Read as ’0’

bit 3 **SSPIF:** Synchronous Serial Port (SSP) Interrupt Flag

1 = The SSP interrupt condition has occurred, and must be cleared in software before returning from the Interrupt Service Routine. The conditions that will set this bit are:

SPI

A transmission/reception has taken place.

I^2C Slave / Master

A transmission/reception has taken place.

I^2C Master

The initiated START condition was completed by the SSP module.
The initiated STOP condition was completed by the SSP module.
The initiated Restart condition was completed by the SSP module.
The initiated Acknowledge condition was completed by the SSP module.
A START condition occurred while the SSP module was IDLE (Multi-master system).
A STOP condition occurred while the SSP module was IDLE (Multi-master system).

0 = No SSP interrupt condition has occurred.

bit 2 **CCP1IF:** CCP1 Interrupt Flag bit

Capture Mode
1 = A TMR1 register capture occurred (must be cleared in software)
0 = No TMR1 register capture occurred
Compare Mode
1 = A TMR1 register compare match occurred (must be cleared in software)
0 = No TMR1 register compare match occurred
PWM Mode
Unused in this mode

bit 1 **TMR2IF:** TMR2 to PR2 Match Interrupt Flag bit

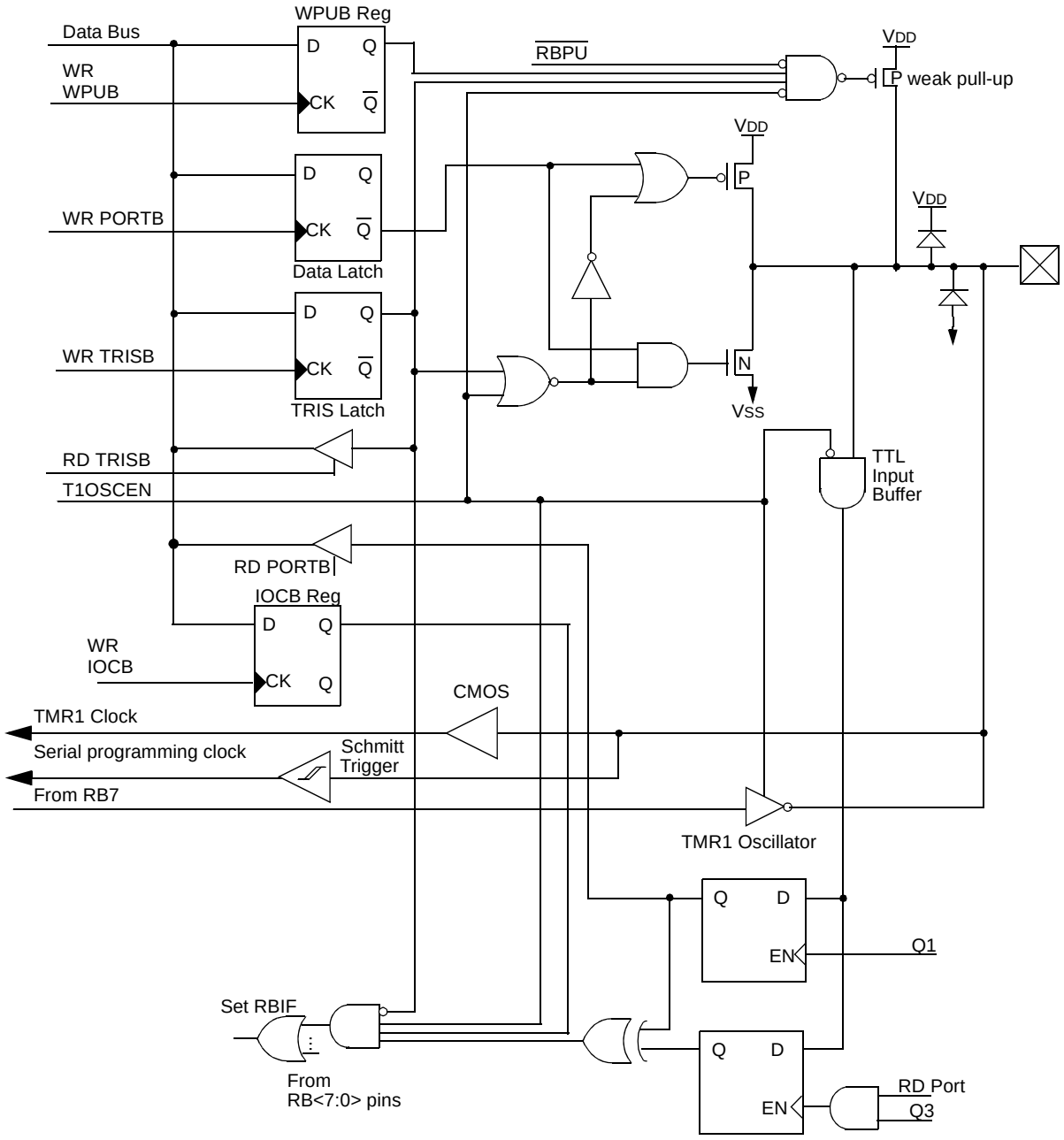
1 = TMR2 to PR2 match occurred (must be cleared in software)
0 = No TMR2 to PR2 match occurred

bit 0 **TMR1IF:** TMR1 Overflow Interrupt Flag bit

1 = TMR1 register overflowed (must be cleared in software)
0 = TMR1 register did not overflow

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

FIGURE 3-9: BLOCK DIAGRAM OF RB6/T1OSO/T1CKI/P1C

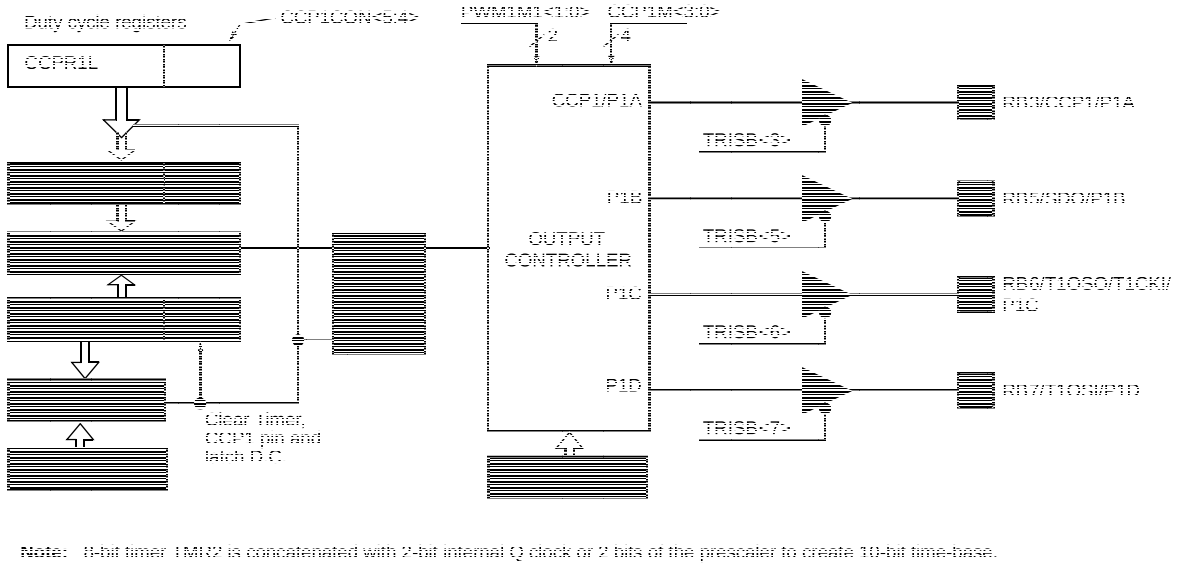


Note: The TMR1 oscillator enable (T1OSCEN = 1) overrides the RB6 I/O port and P1C functions.

8.3 PWM Mode

In Pulse Width Modulation (PWM) mode, the ECCP module produces up to a 10-bit resolution PWM output. Figure 8-3 shows the simplified PWM block diagram.

FIGURE 8-3: SIMPLIFIED PWM BLOCK DIAGRAM



8.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

$$\text{PWM PERIOD} = [(PR2) + 1] \bullet 4 \bullet T_{OSC} \bullet (\text{TMR2 PRESCALE VALUE})$$

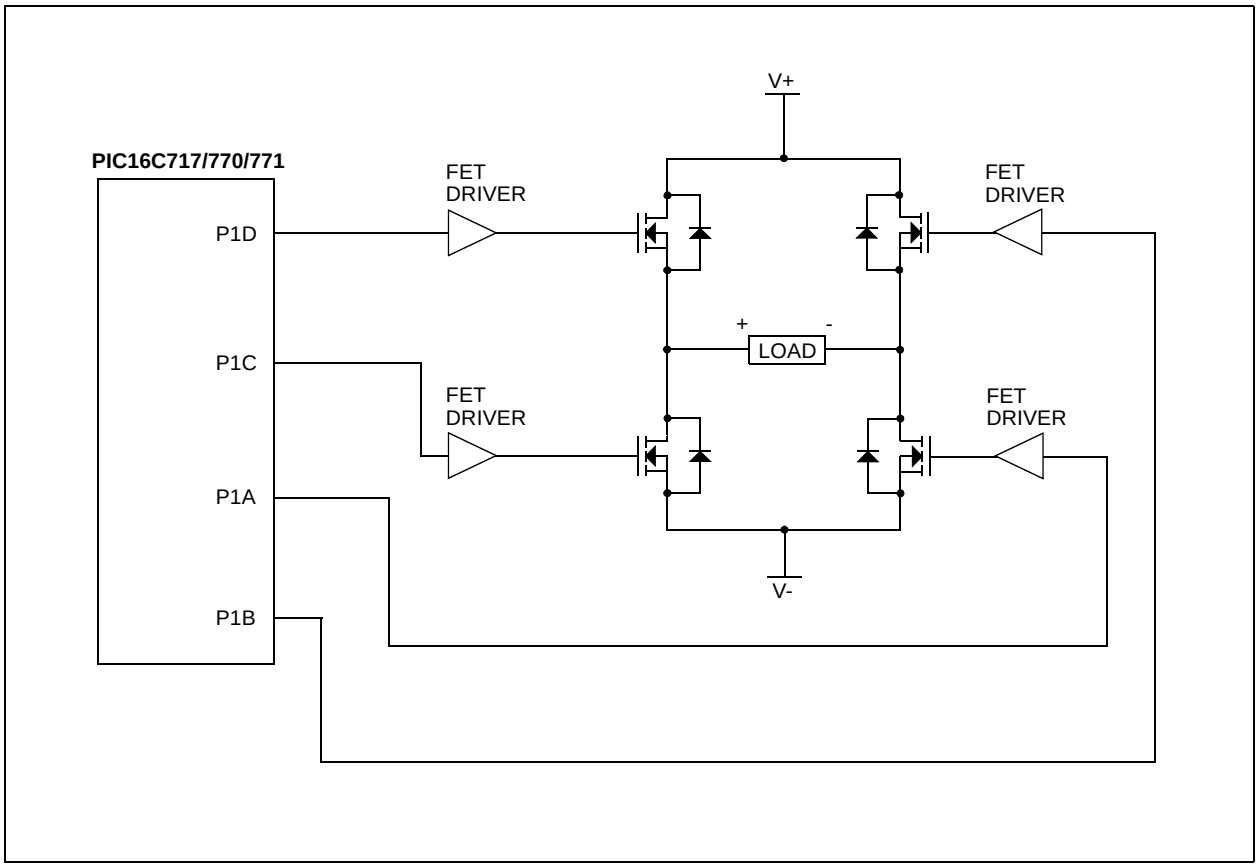
PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

Note:	The Timer2 postscaler (see Section 7.0) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

FIGURE 8-9: EXAMPLE OF FULL-BRIDGE APPLICATION



8.3.7 SYSTEM IMPLEMENTATION

When the ECCP module is used in the PWM mode, the application hardware must use the proper external pull-up and/or pull-down resistors on the PWM output pins. When the microcontroller powers up, all of the I/O pins are in the high-impedance state. The external pull-up and pull-down resistors must keep the power switch devices in the off state until the microcontroller drives the I/O pins with the proper signal levels, or activates the PWM output(s).

8.3.8 START-UP CONSIDERATIONS

Prior to enabling the PWM outputs, the P1A, P1B, P1C and P1D latches may not be in the proper states. Enabling the TRISB bits for output at the same time with the CCP module may cause damage to the power switch devices. The CCP1 module must be enabled in the proper Output mode with the TRISB bits enabled as inputs. Once the CCP1 completes a full PWM cycle, the P1A, P1B, P1C and P1D output latches are properly initialized. At this time, the TRISB bits can be enabled for outputs to start driving the power switch devices. The completion of a full PWM cycle is indicated by the TMR2IF bit going from a '0' to a '1'.

8.3.9 SET UP FOR PWM OPERATION

The following steps should be taken when configuring the ECCP module for PWM operation:

1. Configure the PWM module:
   a) Disable the CCP1/P1A, P1B, P1C and/or P1D outputs by setting the respective TRISB bits.
   b) Set the PWM period by loading the PR2 register.
   c) Set the PWM duty cycle by loading the CCPR1L register and CCP1CON<5:4> bits.
   d) Configure the ECCP module for the desired PWM operation by loading the CCP1CON register. With the CCP1M<3:0> bits select the active high/low levels for each PWM output. With the PWM1M<1:0> bits select one of the available Output modes: Single, Half-Bridge, Full-Bridge, Forward or Full-Bridge Reverse.
   e) For Half-Bridge Output mode, set the dead-band delay by loading the P1DEL register.
2. Configure and start TMR2:
   a) Clear the TMR2 interrupt flag bit by clearing the TMR2IF bit in the PIR1 register.
   b) Set the TMR2 prescale value by loading the T2CKPS<1:0> bits in the T2CON register.
   c) Enable Timer2 by setting the TMR2ON bit in the T2CON register.
3. Enable PWM outputs after a new cycle has started:
   a) Wait until TMR2 overflows (TMR2IF bit becomes a ’1’). The new PWM cycle begins here.
   b) Enable the CCP1/P1A, P1B, P1C and/or P1D pin outputs by clearing the respective TRISB bits.

TABLE 8-3: REGISTERS ASSOCIATED WITH PWM

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	—	ADIF	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF	-0-- 0000	-0-- 0000
8Ch	PIE1	—	ADIE	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE	-0-- 0000	-0-- 0000
86h, 186h	TRISB	PORTB Data Direction Register								1111 1111	1111 1111
11h	TMR2	Timer2 register								0000 0000	0000 0000
92h	PR2	Timer2 period register								1111 1111	1111 1111
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
15h	CCPR1L	Capture/Compare/PWM register1 (LSB)								xxxx xxxx	uuuu uuuu
17h	CCP1CON	PWM1M1	PWM1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000 0000	0000 0000
97h	P1DEL	PWM1 Delay value								0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by ECCP module in PWM mode.

9.1 SPI Mode

The SPI mode allows eight bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally, a fourth pin may be used when in a Slave mode of operation:

- Slave Select ($\overline{SS}$)

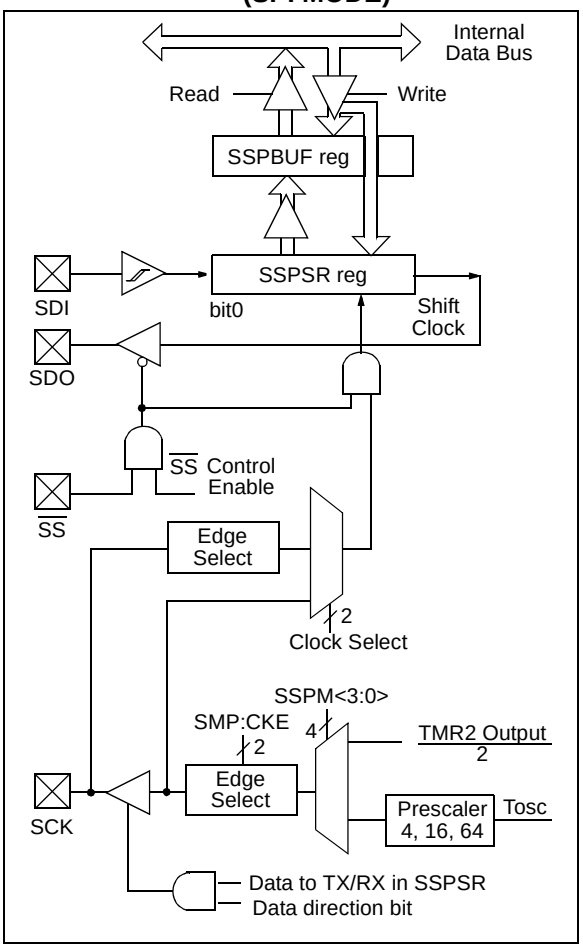
9.1.1 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master Mode (SCK is the clock output)
- Slave Mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data input sample phase (middle or end of data output time)
- Clock edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

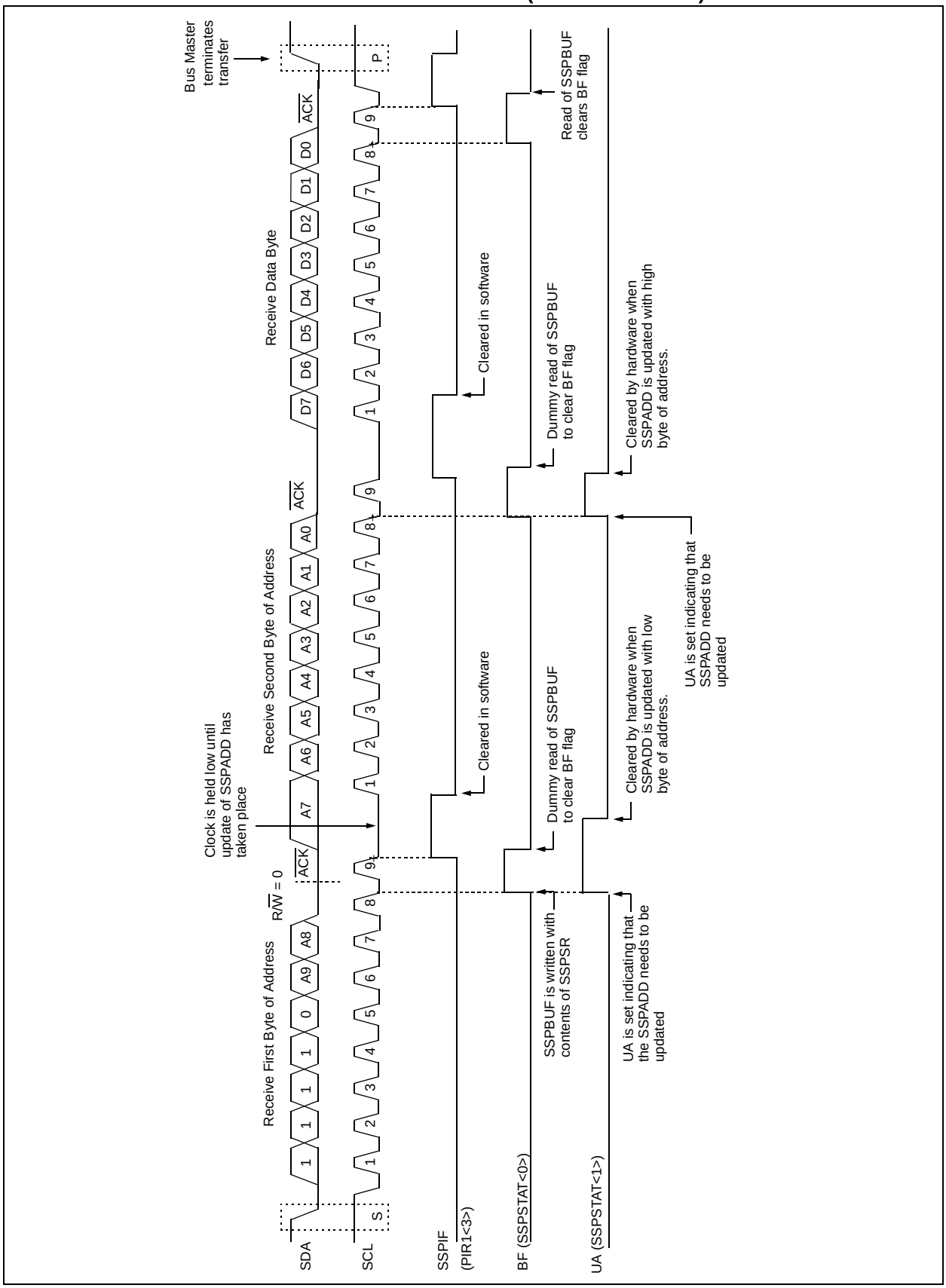
Figure 9-1 shows the block diagram of the MSSP module when in SPI mode.

FIGURE 9-1: MSSP BLOCK DIAGRAM (SPI MODE)



The MSSP consists of a transmit/receive Shift Register (SSPSR) and a Buffer Register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the eight bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit, BF (SSPSTAT<0>), and the interrupt flag bit, SSPIF (PIR1<3>), are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit WCOL (SSPCON<7>) will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

FIGURE 9-9: I²C SLAVE MODE FOR RECEPTION (10-BIT ADDRESS)



11.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The analog-to-digital (A/D) converter module has six inputs for the PIC16C717/770/771.

The PIC16C717 analog-to-digital converter (A/D) allows conversion of an analog input signal to a corresponding 10-bit digital value, while the A/D converter in the PIC16C770/771 allows conversion to a corresponding 12-bit digital value. The A/D module has up to 6 analog inputs, which are multiplexed into one sample and hold. The output of the sample and hold is the input into the converter, which generates the result via successive approximation. The analog reference voltages are software selectable to either the device's analog positive and negative supply voltages (AV_{DD}/AV_{SS}), the voltage level on the V_{REF}+ and V_{REF}- pins, or internal voltage references if enabled (VRH, VRL).

The A/D converter can be triggered by setting the GO/DONE bit, or by the special event Compare mode of the ECCP module. When conversion is complete, the GO/DONE bit returns to '0', the ADIF bit in the PIR1 register is set, and an A/D interrupt will occur, if enabled.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The A/D module has four registers. These registers are:

- A/D Result Register Low ADRESL
- A/D Result Register High ADRESH
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off and any conversion is aborted.

11.1 Control Registers

The ADCON0 register, shown in Register 11-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 11-2, configures the functions of the port pins, the voltage reference configuration and the result format. The ANSEL register, shown in Register 3-1, selects between the Analog or Digital Port Pin modes. The port pins can be configured as analog inputs or as digital I/O.

The combination of the ADRESH and ADRESL registers contain the result of the A/D conversion. The register pair is referred to as the ADRES register. When the A/D conversion is complete, the result is loaded into ADRES, the GO/DONE bit (ADCON0<2>) is cleared, and the A/D interrupt flag ADIF is set. The block diagram of the A/D module is shown in Figure 11-3.

11.4 A/D Conversions

Example 11-1 shows an example that performs an A/D conversion. The port pins are configured as analog inputs. The analog reference V_{REF+} is the device AV_{DD} and the analog reference V_{REF-} is the device AV_{SS}. The A/D interrupt is enabled and the A/D conversion clock is T_{RC}. The conversion is performed on the AN0 channel.

EXAMPLE 11-1: PERFORMING AN A/D CONVERSION

```
    BSF     STATUS, RP0    ;Select Bank 1
    CLRF    ADCON1         ;Configure A/D Voltage Reference
    MOVLW   0x01
    MOVWF   ANSEL          ;disable AN0 digital input buffer
    MOVWF   TRISA          ;RA0 is input mode
    BSF     PIE1, ADIE     ;Enable A/D interrupt
    BCF     STATUS, RP0    ;Select Bank 0
    MOVLW   0xC1           ;RC clock, A/D is on,
                           ;Ch 0 is selected
    MOVWF   ADCON0         ;
    BCF     PIR1, ADIF     ;Clear A/D Int Flag
    BSF     INTCON, PEIE   ;Enable Peripheral
    BSF     INTCON, GIE    ;Enable All Interrupts
;
; Ensure that the required sampling time for the
; selected input channel has lapsed. Then the
; conversion may be started.
    BSF     ADCON0, GO     ;Start A/D Conversion
            :              ;The ADIF bit will be
                           ;set and the GO/DONE bit
            :              ;cleared upon completion-
                           ;of the A/D conversion.
; Wait for A/D completion and read ADRESH:ADRESL for result.
```

12.8 Time-out Sequence

On power-up, the time-out sequence is as follows: First PWRT time-out is invoked by the POR pulse. When the PWRT delay expires, the Oscillator Start-up Timer is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 12-6, Figure 12-7, Figure 12-8 and Figure 12-9 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if $\overline{MCLR}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{MCLR}$ high will begin execution immediately (Figure 12-8). This is useful for testing purposes or to synchronize more than one PIC® microcontroller operating in parallel.

Table 12-5 shows the RESET conditions for some special function registers, while Table 12-6 shows the RESET conditions for all the registers.

12.9 Power Control/STATUS Register (PCON)

The Power Control/STATUS Register, PCON, has two status bits that provide indication of which power-up type RESET occurred.

Bit0 is Brown-out Reset Status bit, $\overline{BOR}$. The $\overline{BOR}$ bit is unknown upon a POR. $\overline{BOR}$ must be set by the user and checked on subsequent RESETS to see if bit $\overline{BOR}$ cleared, indicating a BOR occurred.

Bit1 is $\overline{POR}$ (Power-on Reset Status bit). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

TABLE 12-3: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up		Brown-out	Wake-up from SLEEP
	$\overline{PWRTE}$ = 0	$\overline{PWRTE}$ = 1		
XT, HS, LP	TPWRT + 1024TOSC	1024TOSC	TPWRT + 1024TOSC	1024TOSC
EC, ER, INTRC	TPWRT	—	TPWRT	—

TABLE 12-4: STATUS BITS AND THEIR SIGNIFICANCE

$\overline{POR}$	$\overline{BOR}$	$\overline{TO}$	$\overline{PD}$	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, $\overline{TO}$ is set on $\overline{POR}$
0	x	x	0	Illegal, $\overline{PD}$ is set on $\overline{POR}$
1	0	1	1	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	$\overline{MCLR}$ Reset during normal operation
1	1	1	0	$\overline{MCLR}$ Reset during SLEEP or interrupt wake-up from SLEEP

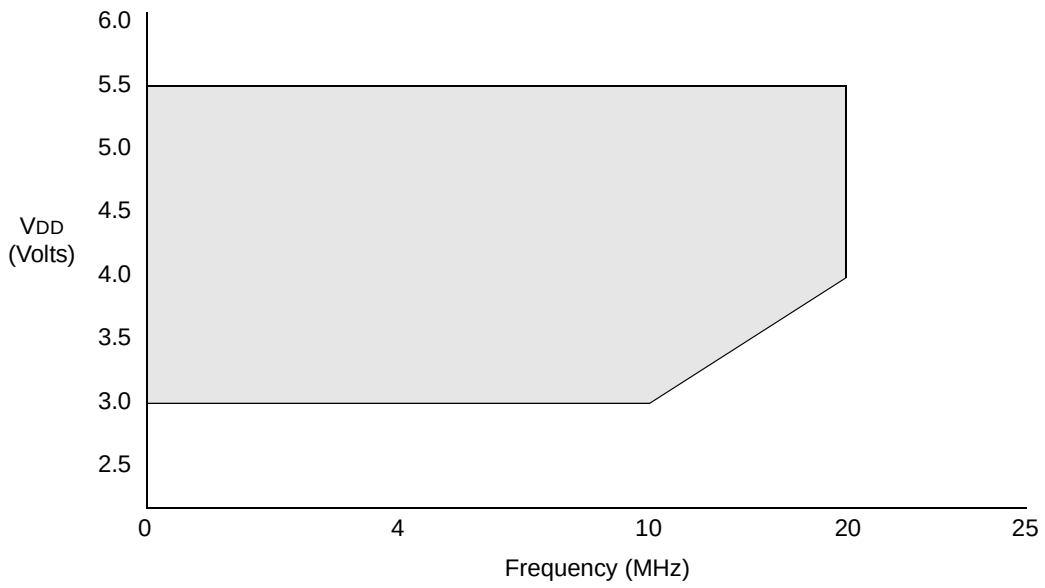
TABLE 12-5: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	---- 1-0x
$\overline{MCLR}$ Reset during normal operation	000h	000u uuuu	---- 1-uu
$\overline{MCLR}$ Reset during SLEEP	000h	0001 0uuu	---- 1-uu
WDT Reset	000h	0000 1uuu	---- 1-uu
WDT Wake-up	PC + 1	uuu0 0uuu	---- u-uu
Brown-out Reset	000h	0001 1uuu	---- 1-u0
Interrupt wake-up from SLEEP, GIE = 0	PC + 1	uuu1 0uuu	---- u-uu
Interrupt wake-up from SLEEP, GIE = 1	0004h	uuu1 0uuu	---- u-uu

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

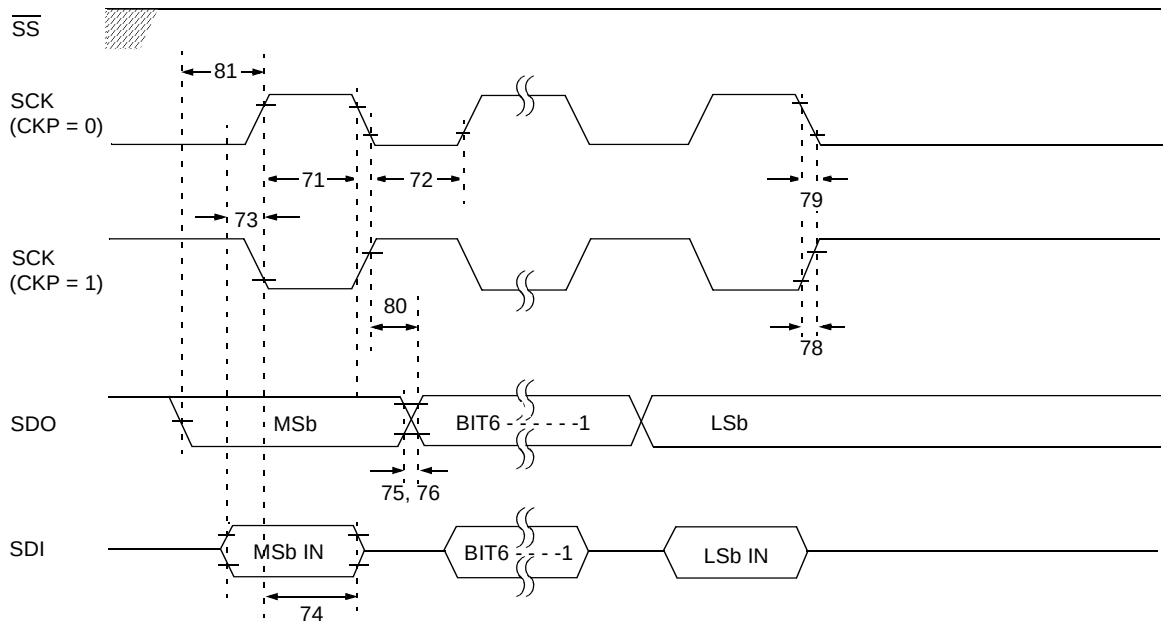
NOTES:

FIGURE 15-3: PIC16LC717/770/771 VOLTAGE-FREQUENCY GRAPH, -40°C ≤ TA ≤ 0°C, +70°C ≤ TA ≤ +85°C



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

FIGURE 15-19: SPI MASTER MODE TIMING (CKE = 1)



Note: Refer to Figure 15-4 for load conditions.

TABLE 15-18: SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
71*	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A*			Single Byte	40	—	—	ns	**Note 1**
72*	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A*			Single Byte	40	—	—	ns	**Note 1**
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A*	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**Note 1**
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75*	TdoR	SDO data output rise time	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
76*	TdoF	SDO data output fall time		—	10	25	ns	
78*	TscR	SCK output rise time (Master mode)	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
79*	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC16**C**XXX	—	—	50	ns	
			PIC16**LC**XXX		—	100	ns	
81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge		TCY	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 15-20: SPI SLAVE MODE TIMING (CKE = 0)

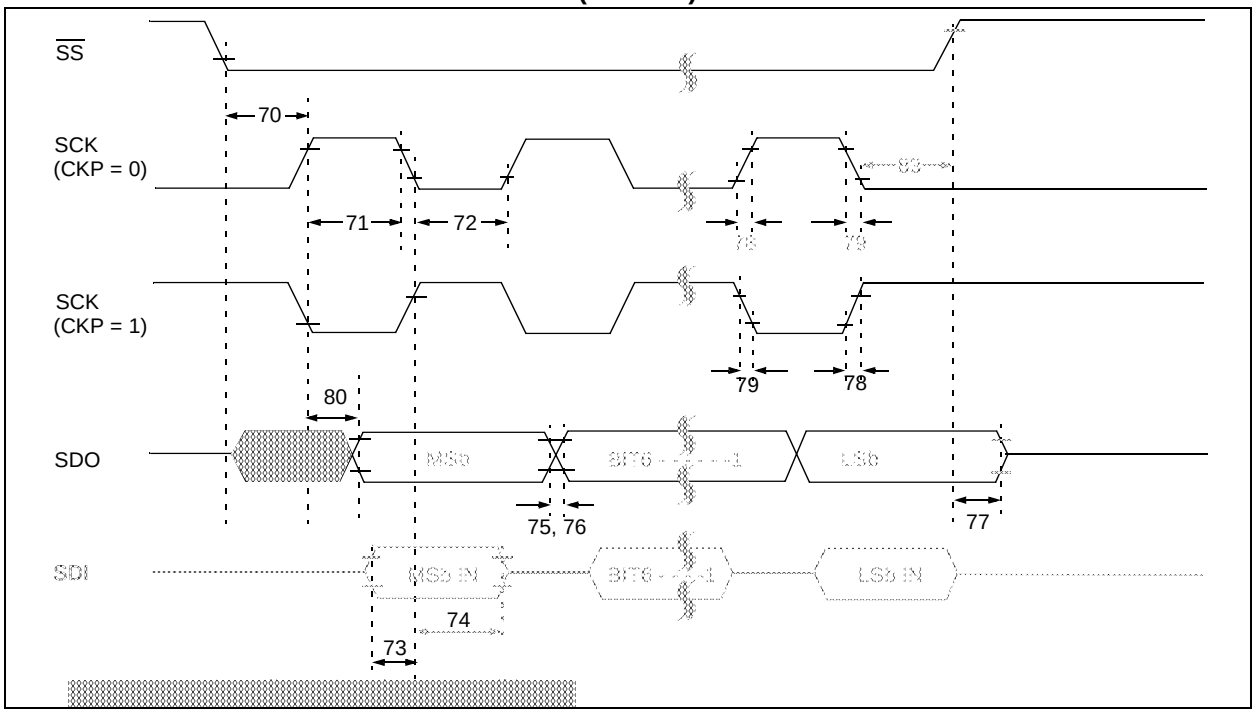


TABLE 15-19: SPI MODE REQUIREMENTS (SLAVE MODE TIMING (CKE = 0)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}$↓ to SCK↓ or SCK↑ input		TCY	—	—	ns	
71*	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A*			Single Byte	40	—	—	ns	**Note 1**
72*	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A*			Single Byte	40	—	—	ns	**Note 1**
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A*	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**Note 1**
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75*	TdoR	SDO data output rise time	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
76*	TdoF	SDO data output fall time		—	10	25	ns	
77*	TssH2doZ	$\overline{SS}$↑ to SDO output hi-impedance		10	—	50	ns	
78*	TscR	SCK output rise time (Master mode)	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
79*	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC16**C**XXX	—	—	50	ns	
			PIC16**LC**XXX		—	100	ns	
83*	TscH2ssH, TscL2ssH	$\overline{SS}$ ↑ after SCK edge		1.5TCY + 40	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 16-12: MAXIMUM IDD VS. VDD (INTRC 37 kHZ MODE)

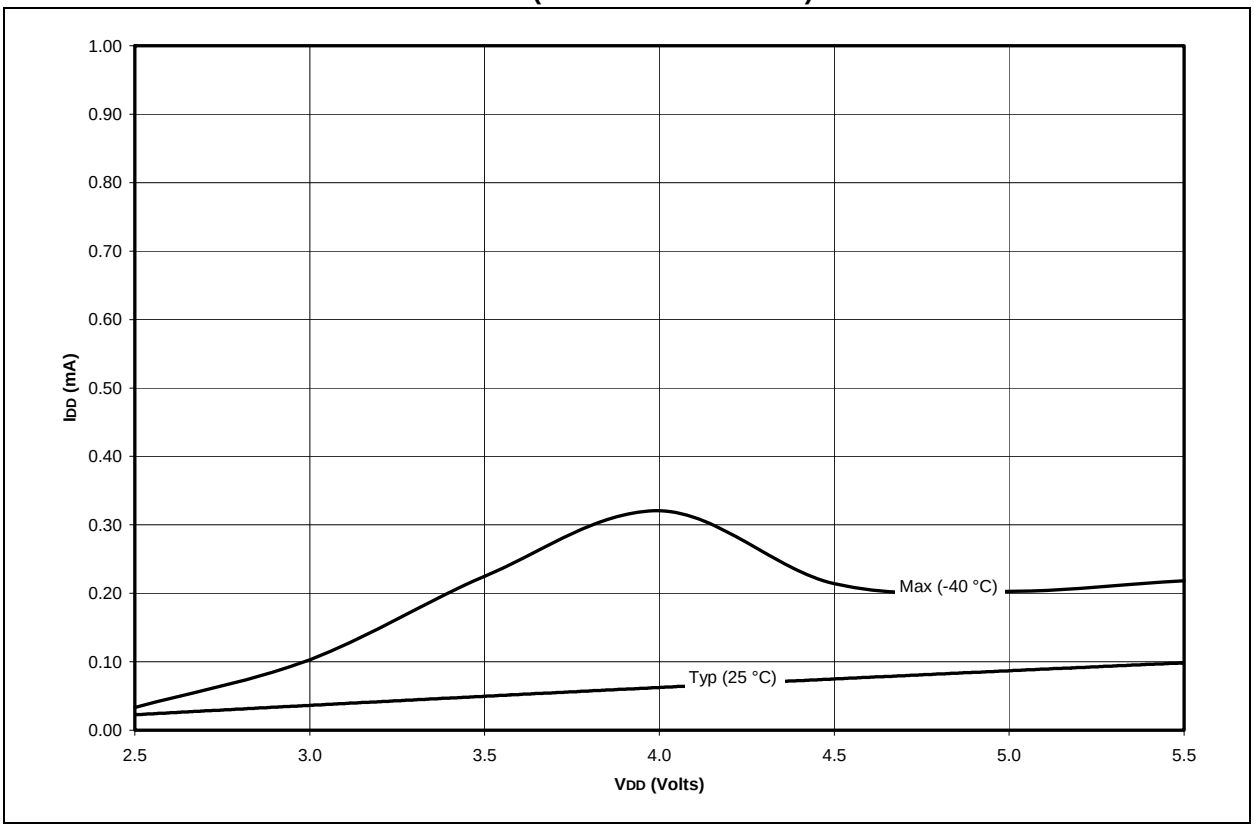
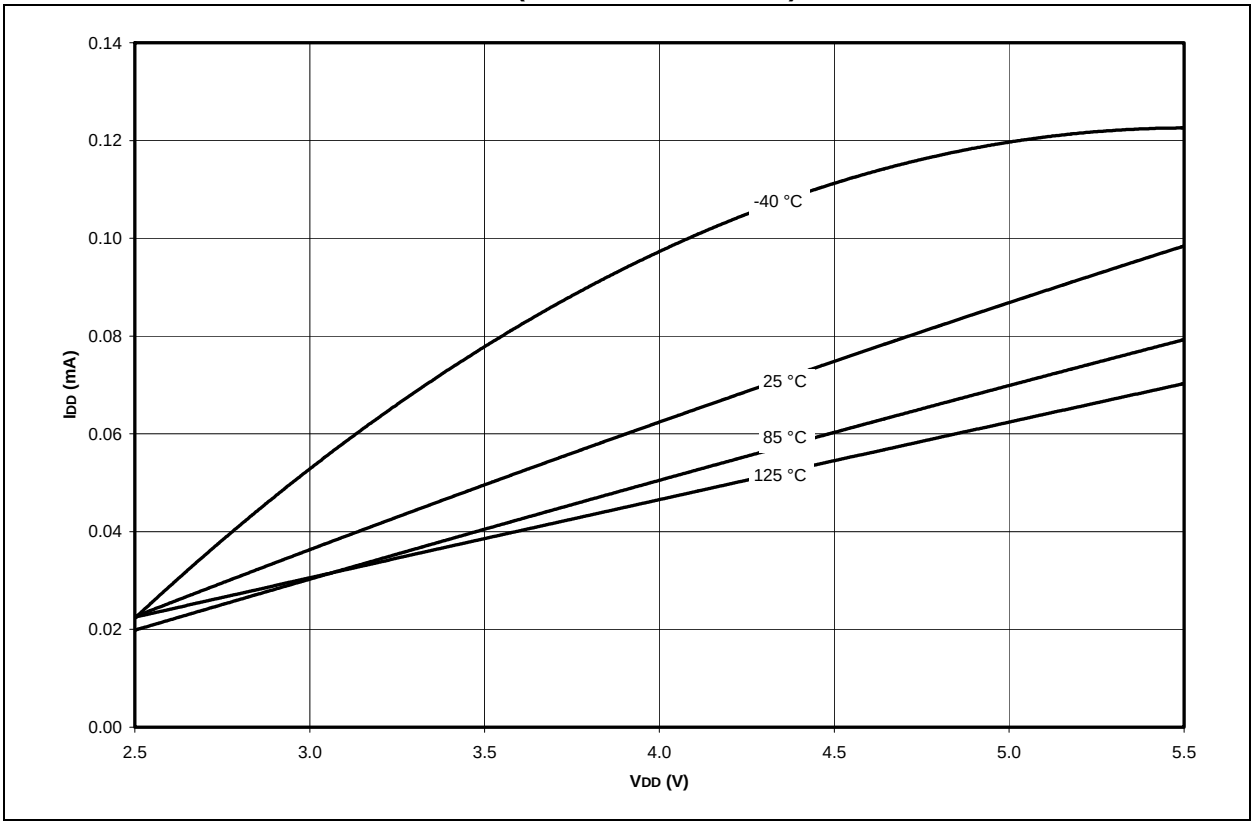
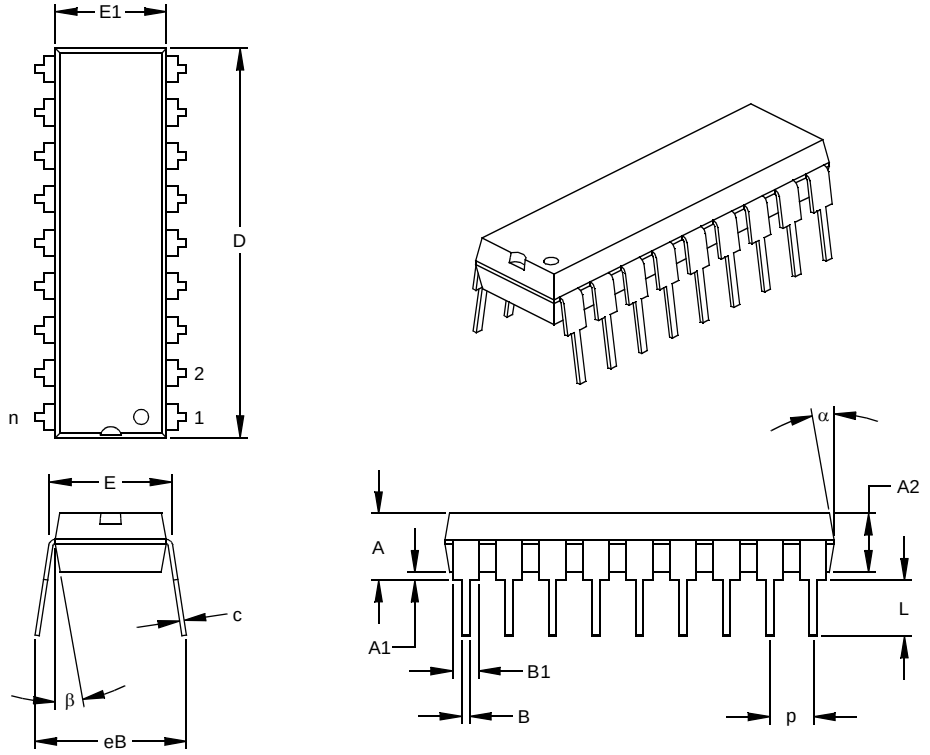


FIGURE 16-13: TYPICAL IDD VS. VDD (INTRC 37 kHZ MODE)



17.2 18-Lead Plastic Dual In-line (P) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.890	.898	.905	22.61	22.80	22.99
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing §	eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-001
Drawing No. C04-007

I